

20V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
	$27m\Omega$ @ $V_{GS} = -4.5V$	-7.6A
-20V	$32\text{m}\Omega$ @ V_{GS} = -2.5V	-6.7A
	50mΩ @ V _{GS} = -1.8V	-5.2A
	90mΩ @ V _{GS} = -1.5V	-3.9A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- **Battery Management Application**
- **Power Management Functions**
- DC-DC Converters

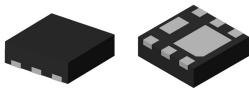
Features

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

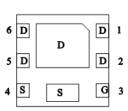
- Case: U-DFN2020-6 (Type F)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.007 Grams (Approximate)

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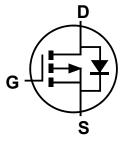


Top View

Bottom View



Pin Out **Bottom View**



Internal Schematic

Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Quantity per reel
DMP2023UFDF-7	3F	7	3,000
DMP2023UFDF-13	3F	13	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

U-DFN2020-6



3F = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014)M = Month (ex: 9 = September)

Date Code Key

Year	2014		2015	2016		2017	2018		2019	2020		2021
Code	В		С	D		Е	F		G	Н		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	1	5	6	7	Q	0	0	NI	ח



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V_{DSS}	-20	V		
Gate-Source Voltage			V_{GSS}	±8	V
Continuous Drain Current (Note 6) V - 4 EV	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-7.6 -6.1	Α
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<5s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	Ι _D	-9.5 -7.6	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I_{DM}	-40	Α		
Continuous Source-Drain Diode Current	Is	-2	Α		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	- 23	Α		
Repetitive Avalanche Energy (Note 7) L = 0.1mH	E _{AS}	27	mJ		

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Dower Dissination (Note 5)	T _A = +25°C	Б	0.73	W	
Total Power Dissipation (Note 5)	T _A = +70°C	P_D	0.47	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	П	171	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<5s	$R_{\theta JA}$	112	C/VV	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	В	2.03	W	
Total Power Dissipation (Note 6)	T _A = +70°C	P_{D}	1.30	VV	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Steady State			
Thermal Resistance, Junction to Ambient (Note 6)	t<5s	$R_{\theta JA}$	40	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Steady State	$R_{ heta JC}$	9.3		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

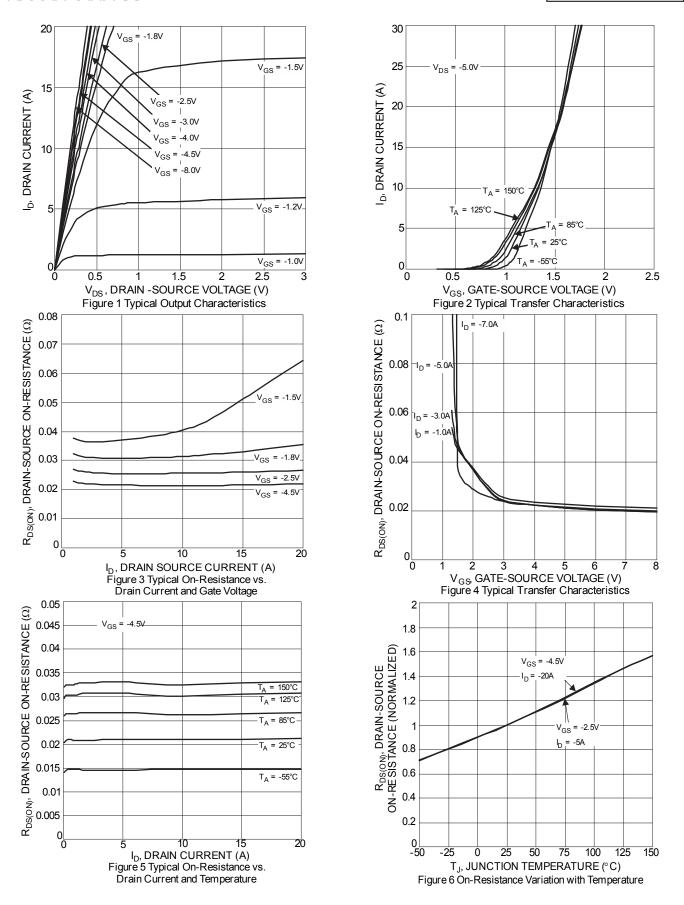
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_		-1	μΑ	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)						•	
Gate Threshold Voltage	V _{GS(th)}	-0.4		-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
				27		$V_{GS} = -4.5V, I_D = -7.0A$	
Static Drain-Source On-Resistance	D			32	mΩ	$V_{GS} = -2.5V$, $I_D = -5.0A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	_	50	11177	$V_{GS} = -1.8V$, $I_D = -3.0A$	
			_	90		$V_{GS} = -1.5V, I_D = -1.0A$	
Diode Forward Voltage	V _{SD}	_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -1.0A$	
DYNAMIC CHARACTERISTICS (Note 9)						•	
Input Capacitance	C _{iss}	_	1837	_			
Output Capacitance	Coss	_	131	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	115	_		1 - 1.01/11/12	
Gate Resistance	R_{g}	_	14.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qq	_	27	_			
Gate-Source Charge	Q_{gs}	_	2.8	_	nC	$V_{DS} = -15V, V_{GS} = -4.5V,$ $I_{D} = -4.0A$	
Gate-Drain Charge	Q _{qd}	_	3.1	_		ID = -4.0A	
Turn-On Delay Time	t _{D(on)}	_	5.8	_			
Turn-On Rise Time	t _r	_	19.3	_		$V_{DS} = -15V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t _{D(off)}	_	168.5	_	ns	$R_G = 1\Omega, I_D = -4.0A$	
Turn-Off Fall Time	t _f	_	77.3	_			
Reverse Recovery Time	t _{rr}	_	46.5	_	ns	I _F = -1.0A, di/dt = 100A/μs	
Reverse Recovery Charge	Q _{rr}	_	33.8	_	nC	I _F = -1.0A, di/dt = 100A/µs	

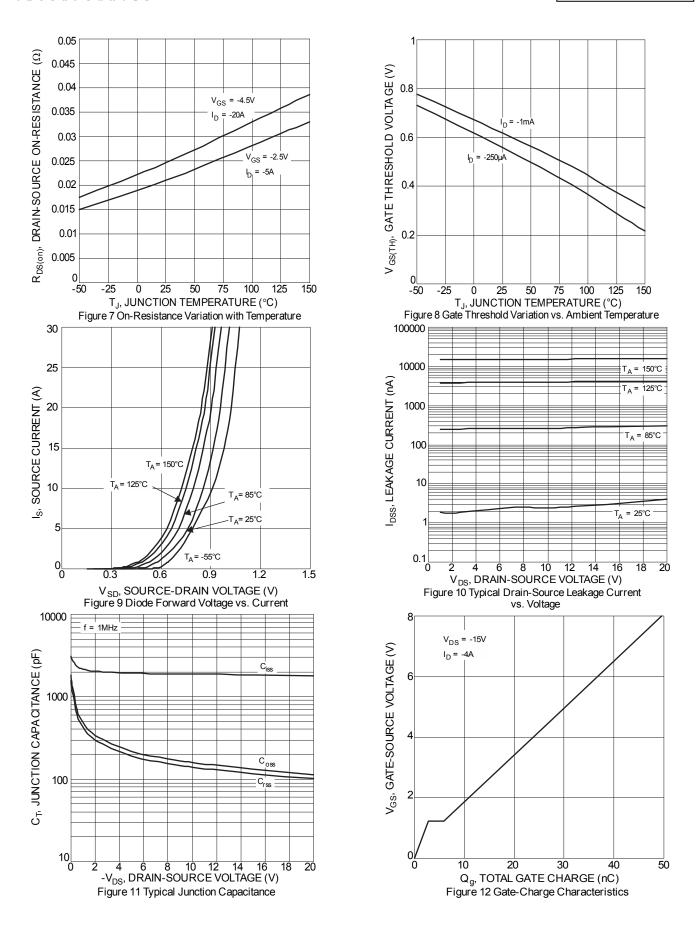
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.
 Short duration pulse test used to minimize self-heating effect. Notes:

9. Guaranteed by design. Not subject to product testing.



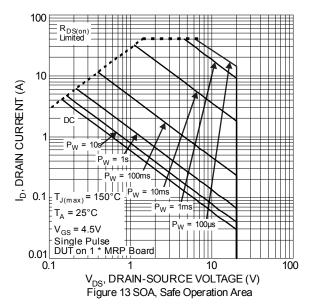


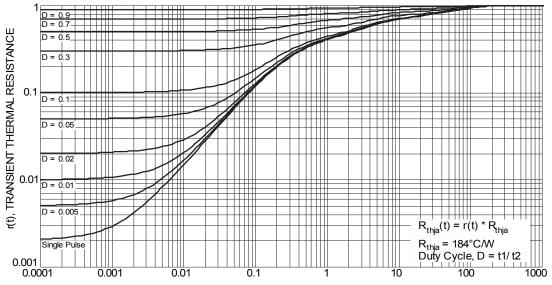




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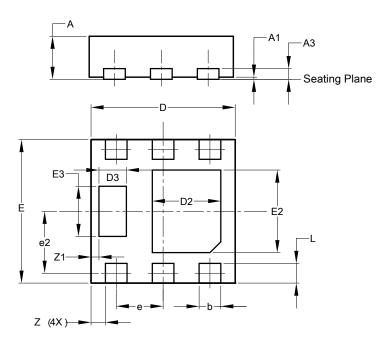


t1, PULSE DURATION TIMES (sec) Figure 14 Transient Thermal Resistance



Package Outline Dimensions

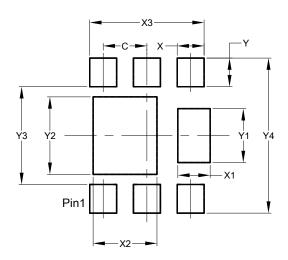
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



U-DFN2020-6										
	(Type F)									
Dim	Min	Min Max Typ								
Α	0.57	0.63	0.60							
A1	0	0.05	0.03							
A3	-	-	0.15							
b	0.25	0.35	0.30							
D	1.95	2.05	2.00							
D2	0.85 1.05 0.95									
D3	0.33 0.43 0.38									
е	0.65 BSC									
e2	C).863 B	SC							
Е	1.95	2.05	2.00							
E2	1.05	1.25	1.15							
E3	0.65	0.65 0.75 0.70								
L	0.225	0.325	0.275							
Z		0.20 BSC								
Z 1	C	0.110 BSC								
All	Dimen	sions i	in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.650
Х	0.400
X1	0.480
X2	0.950
Х3	1.700
Υ	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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